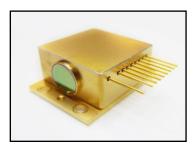
4.73 µm DISTRIBUTED FEEDBACK (DFB) QCL





HIGH HEAT LOAD (HHL) PACKAGE

OVERVIEW

- Thermo-electrically cooled. External heat sink still required.
- Sealed in a nitrogen-purged atmosphere.
- Package dimensions (approx): 1.75 x 1.25 x 0.72 in (excluding pins).

LASER SPECIFICATIONS

		Specs	Units
Process		DFB	
Oper. Temperature		15 – 45	°C
Facet Coating	Front	AR	
	Back	HR	

ELECTRO-OPTICAL CHARACTERIZATION

		Specs	Units
Driving Conditions	Operation Mode	CW	
	Temperature	15	°C
Electrical	Thresh. Current	0.25	Α
	Max. Current	0.34	Α
	Thresh. Voltage	14.2	V
	Max. Voltage	15.1	V
	Laser Efficiency	1.2	%
Optical	Max. Power Output	68.3	mW
	Center Wavelength	4.73	μm

SPECTRAL CHARACTERIZATION AND BEAM QUALITY

		Specs	Units
Driving Conditions	Operation Mode	CW	
Wavelength Tuning	Temperature	0.40	nm/K
	Current	83.3	nm/A
SMSR		30	dB
Beam Profile	Full Beam Waist	2.89	mm
	M ²	1.27	